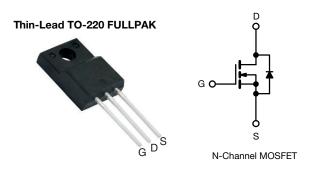
**Vishay Siliconix** 

www.vishay.com

## **EL Series Power MOSFET**



PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.171				
Q <sub>g</sub> max. (nC)	74					
Q <sub>gs</sub> (nC)	15					
Q <sub>gd</sub> (nC)	15					
Configuration	Single					

### FEATURES

- Reduced figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
  - Switch mode power supplies (SMPS)
  - Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA22N60EL-E3
Lead (Pb)-free and halogen-free	SiHA22N60EL-GE3

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	v	
Gate-source voltage			V <sub>GS</sub>	± 30	v	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	21		
	VGS AL TO V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	13	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	45		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	286	mJ	
Maximum power dissipation	imum power dissipation			35	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		d\//dt	62	V/ns	
Reverse diode dV/dt <sup>d</sup>		dV/dt 22		22	v/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.5 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D,\,dI/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			20.44			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.6				°C/W		
	·	•						
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static					•	•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	, I <sub>D</sub> = 1 mA	-	0.71	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3	-	5	V
	1	$V_{GS} = \pm 20 V$		V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zero gate voltage drain current	1	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA	
	IDSS	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			-	-		10
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A		-	0.171	0.197	Ω
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub>	= 20 V, I <sub>D</sub> =	= 11 A	-	6.5	-	S
Dynamic	-					-		
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$		-	1690	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$		-	95	-		
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	2	-	5	-	1
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>					85	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{\rm DS} = 0$	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		-	296	-	
Total gate charge	Qq		I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V		-	37	74	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	15	-	nC	
Gate-drain charge	Q <sub>gd</sub>				-	15	-	1
Turn-on delay time	t <sub>d(on)</sub>	1			-	22	44	
Rise time	t <sub>r</sub>	$\begin{array}{l} V_{DD}=480 \; V,  I_{D}=11 \; A, \\ V_{GS}=10 \; V,  R_{g}=9.1 \; \Omega \end{array}$		-	46	92	- ns	
Turn-off delay time	t <sub>d(off)</sub>			-	27	54		
Fall time	t <sub>f</sub>	1			-	24		48
Gate input resistance	R <sub>g</sub>	f = 1	MHz, oper	n drain	-	0.65	-	Ω

date inpat redictance	r ig			0.00					
Drain-Source Body Diode Characteristics									
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the	-	-	21				
Pulsed diode forward current	I <sub>SM</sub>	p - n junction diode	-	-	45	A			
Diode forward voltage	V <sub>SD</sub>	$T_{J} = 25 \text{ °C}, I_{S} = 11 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	1.2	V			
Reverse recovery time	t <sub>rr</sub>	T 0500 H H 44 A	-	365	-	ns			
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 11 A, dl/dt = 100 A/µs, V <sub>B</sub> = 25 V	-	5.8	-	μC			
Reverse recovery current	I <sub>RRM</sub>		-	29	-	А			

#### Notes

a.  $C_{oss(er)}$  s a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

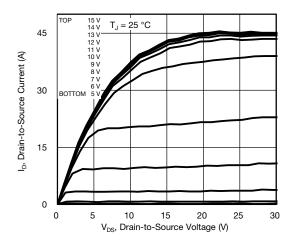
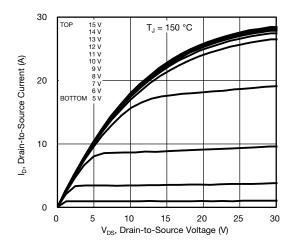
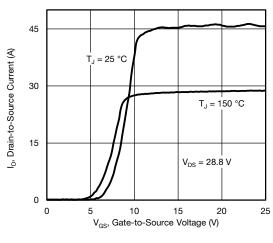


Fig. 1 - Typical Output Characteristics









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3.0 R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 10\ GS 0.5 0 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

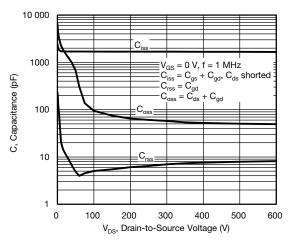


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

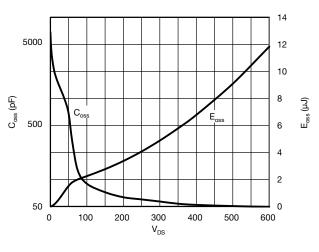


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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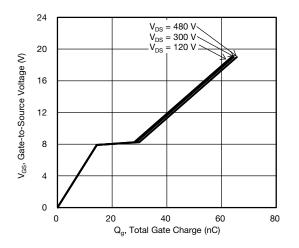


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

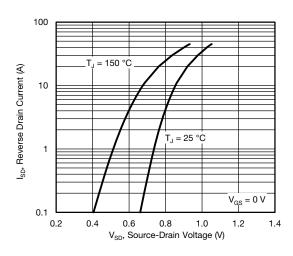
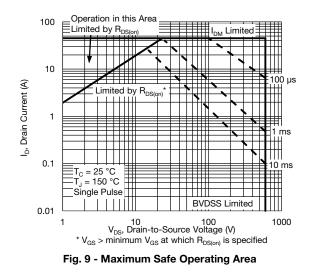


Fig. 8 - Typical Source-Drain Diode Forward Voltage



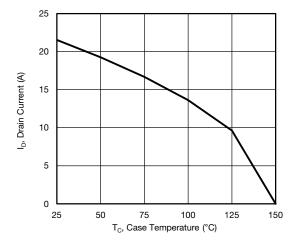


Fig. 10 - Maximum Drain Current vs. Case Temperature

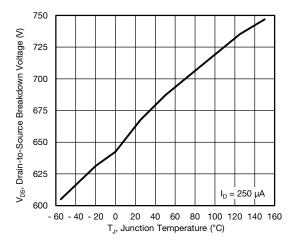


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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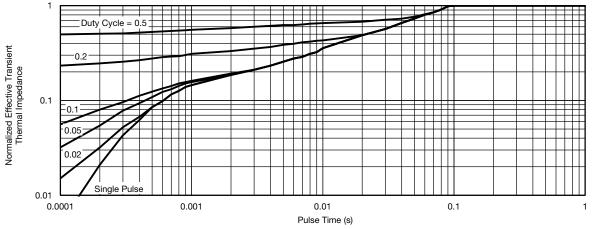


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

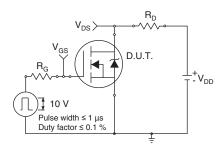


Fig. 13 - Switching Time Test Circuit

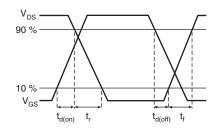


Fig. 14 - Switching Time Waveforms

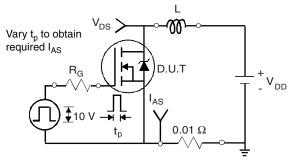


Fig. 15 - Unclamped Inductive Test Circuit

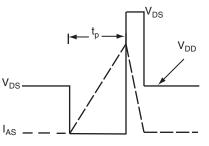


Fig. 16 - Unclamped Inductive Waveforms

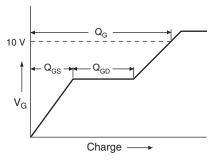


Fig. 17 - Basic Gate Charge Waveform

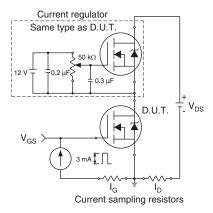


Fig. 18 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit

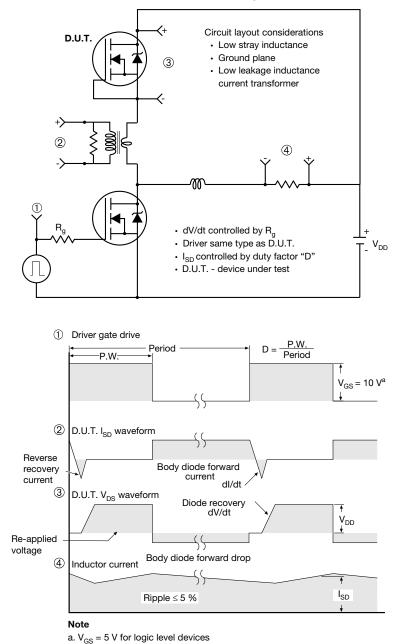


Fig. 19 - For N-Channel

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